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AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the

application:

LISTING OF CLAIMS:

Claims 1-6 (canceled).

Claim 7 (new): A surface mountable device comprising;

a substrate including a first principal surface, a second principal surface, and a

side surface connecting the first principal surface to the second principal surface;

a terminal electrode disposed on the first principal surface; and

a first conductor for appearance inspection extending continuously from the

terminal electrode to the side surface and having a width less than a width of the

terminal electrode.

Claim 8 (new): The surface mountable device according to claim 7, further

comprising a second conductor for appearance inspection disposed on the side surface

of the substrate, the second conductor for appearance inspection being arranged to be

continuous from an extended end of the first conductor for appearance inspection.

Claim 9 (new): The surface mountable device according to claim 8, wherein the

second conductor for appearance inspection extends in a direction that is substantially

perpendicular to the first conductor for appearance inspection.

Claim 10 (new): The surface mountable device according to claim 8, wherein the

first conductor for appearance inspection and the second conductor for appearance

inspection are arranged in a T shape.

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Claim 11 (new): The surface mountable device according to claim 8, wherein a dimension of the second conductor for appearance inspection in a horizontal direction is

about 100 µm to about 300 µm

Claim 12 (new): The surface mountable device according to claim 7, wherein a

width of the first conductor for appearance inspection is about 100 µm or less.

Claim 13 (new): The surface mountable device according to claim 7, wherein a

height of the first conductor for appearance inspection is about 100 µm.

Claim 14 (new): The surface mountable device according to claim 7, wherein the

first conductor for appearance inspection extends from the terminal electrode to the

inside of the substrate.

Claim 15 (new): The surface mountable device according to claim 7, wherein at

least two first conductors for appearance inspection are disposed continuously at the

terminal electrode.

Claim 16 (new): The surface mountable device according to claim 11, wherein

said at least two first conductors for appearance inspection are disposed continuously at

both ends of the terminal electrode.

Claim 17 (new): The surface mountable device according to claim 16, wherein

said at least two first conductors extend upward from both ends of the terminal

electrode at an oblique angle with respect to the terminal electrode.

Claim 18 (new): The surface mountable device according to claim 16, further

comprising at least two second conductors for appearance inspection disposed on the

side surface of the substrate, the at least two second conductors for appearance

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inspection being continuous from the extended ends of the at least two first conductors

for appearance inspection.

Claim 19 (new): The surface mountable device according to claim 18, wherein

said at least two second conductors for appearance inspection extend in a substantially

horizontal direction.

Claim 20 (new): The surface mountable device according to claim 7, wherein a

gold plating is disposed on said first conductor for appearance inspection.

Claim 21 (new): The surface mountable device according to claim 7, wherein a

gold plating is disposed on said terminal electrode.

Claim 22 (new): The surface mountable device according to claim 7, wherein a

gold plating is disposed on said first conductor for appearance inspection and said

terminal electrode.